



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. Ahn et al.

Examiner:

David S. Blum

Serial No.:

09/945,535

Group Art Unit:

2813

Filed:

August 30, 2001

Docket:

1303.026US1

Title:

HIGHLY RELIABLE AMORPHOUS HIGH-K GATE OXIDE ZrO2

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(c)(2), Applicants have included the fee of \$180.00 as set forth in 37 C.F.R. §1.17(p). Please charge any additional fees or credit any overpayment to Deposit Account No. 19-0743.

02/08/2006 HDESTA1 00000036 190743 09945535

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Serial No :09/945,535 Filing Date: August 30, 2001

Title: HIGHLY RELIABLE AMORPHOUS HIGH-K GATE OXIDE ZrO2

Pursuant to 37 C.F.R. 1.98(a)(2), Applicant believes that copies of cited U.S. Patents and Published Applications are no longer required to be provided to the Office. Notification of this change was provided in the United States Patent and Trademark Office OG Notices dated October 12, 2004. Thus, Applicant has not included copies of any US Patents or Published Applications cited with this submission. Should the Office require copies to be provided, Applicant respectfully requests that notice of such requirement be directed to Applicant's belowsigned representative. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this _____ day of February, 2006.

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Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Substitute for form 1449A/PTO omplete if Known INFORMATION DISCLOSURE 09/945,535 **Application Number** STATEMENT BY APPLICANT August 30, 2001 Filing Date Ahn, Kie **First Named Inventor** 2813 **Group Art Unit** Blum, David **Examiner Name** Attorney Docket No: 1303.026US1

US PATENT DOCUMENTS							
Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Filing Date If Appropriate			
	US-20020001971A1	01/03/2002	Cho, H.	06/27/2001			
· · · · · · · · · · · · · · · · · · ·	US-20030003635A1	01/02/2003	Paranjpe, A. P., et al.	05/23/2001			
	US-20030181060A1	09/25/2003	Asai, M., et al.	02/25/2003			
	US-20040161899A1	08/19/2004	Luo, T. Y., et al.	02/14/2003			
•	US-20050227442A1	10/13/2005	Ahn, K. Y., et al.	06/09/2005			
	US-20050277256A1	12/15/2005	Ahn, K. Y., et al.	07/11/2005			
	US-20050280067A1	12/22/2005	Ahn, K. Y., et al.	08/26/2005			
	US-20060001151A1	01/05/2006	Ahn, K. Y., et al.	08/26/2005			
	US-20060003517A1	01/05/2006	Ahn, K. Y., et al.	08/29/2005			
	US-6,404,027	06/11/2002	Hong, Minghwei, et al.	02/07/2000			
	US-6,441,417	08/27/2002	Zhang, Fengyan, et al.	03/28/2001			
	US-6,444,592	09/03/2002	Ballantine, A. W., et al.	06/20/2000			
**	US-6,979,855	12/27/2005	Ahn, K. Y., et al.	01/27/2004			

FOREIGN PATENT DOCUMENTS								
Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	T²				
	EP-1122795A2	08/08/2001	Hong, M., et al.					

	OTHE	R DOCUMENTS NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
		IWAMOTO, K., et al., "Advanced Layer-By-Layer Deposition and Annealing Process For High-Quality High-K Dielectrics Formation", Electrochemical Society Proceedings Vol. 2003 (14), (2003),265-272	
		NAKAJIMA, et al., "Atomic-layer-deposited silicon-nitride/SiO2 stacked gate dielectrics for highly reliable p-metal-oxide-semiconductor filed-effect transistors", Applied Physics Letters, Vol. 77, (October 2000),2855-2857	